

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese

FDP2 N-Cha	оростоя [®] 572 nnel PowerTrench [®] M 9 A, 54 mΩ	OSFET	Octo	ober 2013 ®
Features		Applications		
 Q_{G(tot)} = 26 Low Miller Low Q_{rr} B UIS Capa 	-	 Consumer Appliances Synchronous Rectification Battery Protection Circuit Motor drives and Uninter Micro Solar Inverter 		ies
MOSFE	T Maximum Ratings T _C = 25°C	unless otherwise noted		
				11:::14
Symbol	Drain to Source Voltage		FDP2572	Unit
Symbol V _{DSS}	Drain to Source Voltage		FDP2572 150 ±20	Unit V V
Symbol V _{DSS}			150	V
Symbol V _{DSS}	Drain to Source Voltage Gate to Source Voltage Drain Current		150	V
Symbol V _{DSS} V _{GS}	Drain to Source Voltage Gate to Source Voltage Drain Current Continuous (T _C = 25°C, V _{GS} = 10V)		150 ±20	V V
Symbol V _{DSS} V _{GS}	Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$)	A = 43°C/W)	150 ±20 29	V V A
Symbol V _{DSS} V _{GS}	Drain to Source Voltage Gate to Source Voltage Drain Current Continuous (T _C = 25°C, V _{GS} = 10V)	A = 43°C/W)	150 ±20 29 20	V V A A
Symbol V _{DSS} V _{GS}	$\label{eq:constraint} \begin{array}{l} \mbox{Drain to Source Voltage} \\ \mbox{Gate to Source Voltage} \\ \mbox{Drain Current} \\ \mbox{Continuous (T_C = 25^{\circ}C, V_{GS} = 10V)} \\ \mbox{Continuous (T_C = 100^{\circ}C, V_{GS} = 10V)} \\ \mbox{Continuous (T_{amb} = 25^{\circ}C, V_{GS} = 10V, R_{\theta J})} \end{array}$	A = 43°C/W)	150 ±20 29 20 4	V V A A A
Symbol V _{DSS} V _{GS} I _D E _{AS}	Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, $R_{\theta J}$ Pulsed	A = 43°C/W)	150 ±20 29 20 4 Figure 4	V V A A A A A
Symbol V _{DSS} V _{GS}	Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, $R_{\theta J}$ Pulsed Single Pulse Avalanche Energy (Note 1)	A = 43°C/W)	150 ±20 29 20 4 Figure 4 36	V V A A A A M J mJ

Derate above 25°C

T _J , T _{STG}	Operating and Storage Temperature	-55 to 175
Thermal	Characteristics	
-		

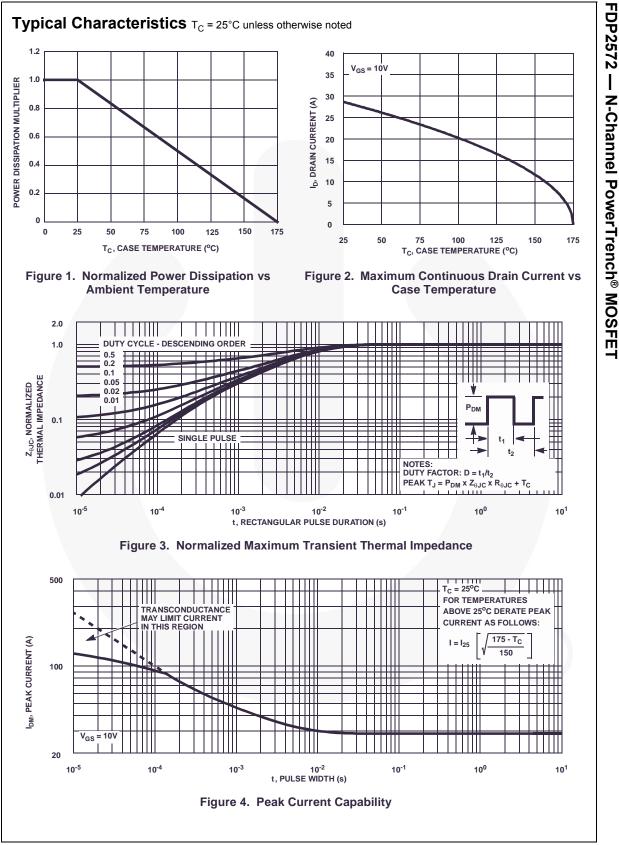
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.11	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max. (Note 2)	62.5	°C/W

1

°C

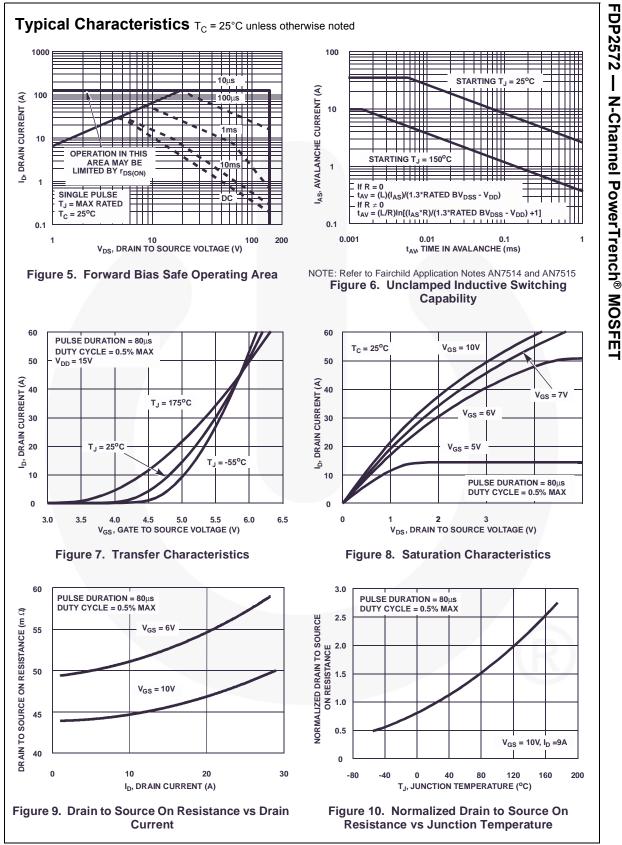
FDP2	/larking	Device Package Reel Size		Reel Size	Tape	Width	Qua	ntity
1012	2572	FDP2572	TO-220	Tube	N/	A	50 units	
Electrica	al Char	acteristics T _C = 25°C	unless otherwise	noted				
Symbol		Parameter	Test C	onditions	Min	Тур	Max	Unit
Off Chara	cteristic	S						
B _{VDSS}	Drain to S	ource Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		150	-	-	V
I _{DSS}	Zero Gate	e Voltage Drain Current	V _{DS} = 120V		-	-	1	μA
'DSS			$V_{GS} = 0V$	T _C = 150 ^o	-	-	250	μΛ
I _{GSS}	Gate to S	ource Leakage Current	V _{GS} = <u>+2</u> 0V		-	-	±100	nA
On Chara	cteristic	5						
V _{GS(TH)}	Gate to S	ource Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA		2	-	4	V
		Ŭ	I _D = 9A, V _{GS} =		-	0.045	0.054	
r _{DS(ON)}	Drain to S	Source On Resistance	$I_D = 4A, V_{GS}$		-	0.050	0.075	Ω
- \ /				10V, T _C =175°C	-	0.126	0.146	
Dynamic	Characte	eristics						
C _{ISS}	Input Cap				-	1770	-	pF
C _{OSS}	Output Ca	apacitance	$V_{DS} = 25V, V$	_{GS} = 0V,	-	183	-	pF
C _{RSS}	Reverse 7	Fransfer Capacitance	f = 1MHz			40	-	pF
Q _{g(TOT)}	Total Gate	e Charge at 10V	V _{GS} = 0V to ²	10V	-	26	34	nC
Q _{g(TH)}	-	I Gate Charge		2V V _{DD} = 75V	-	3.3	4.3	nC
Q _{gs}	-	ource Gate Charge		I _D = 9A	-	8	-	nC
Q _{gs2}	-	rge Threshold to Plateau		$I_{g} = 1.0 \text{mA}$	-	5	-	nC
Q _{gd}	_	rain "Miller" Charge		Ŭ.	-	6	-	nC
	Switchir	ng Characteristics (V _c	$h_{0} = 10V$					
t _{ON}	Turn-On 1	-	,5 .00)		-	-	36	ns
t _{d(ON)}		Delay Time			-	11	-	ns
t _r	Rise Time	,	V _{DD} = 75V, I _D	= 94	/	14	-	ns
t _{d(OFF)}		Delay Time	$V_{GS} = 10V, F$			31	-	ns
t _f	Fall Time				-	14	-	ns
t _{OFF}	Turn-Off 1	Time				-	66	ns
		le Characteristics				I		
			I _{SD} = 9A		-	- /	1.25	V
V _{SD}	Source to	Drain Diode Voltage	I _{SD} = 4A		-	-	1.0	V
t _{rr}	Reverse F	Recovery Time		_D /dt =100A/µs	- /	-	74	ns
		Recovered Charge		/dt =100A/μs	-	-	169	nC

©2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1



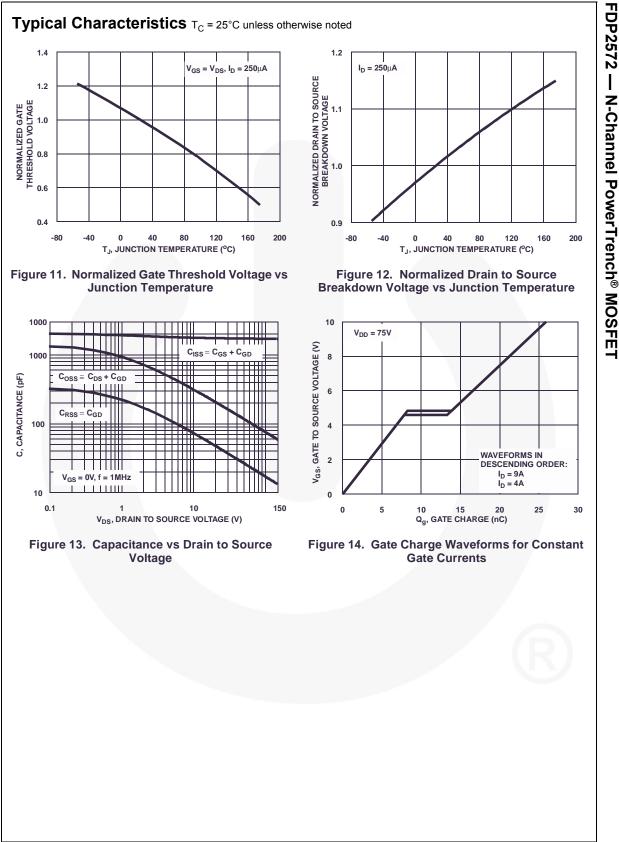
©2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1

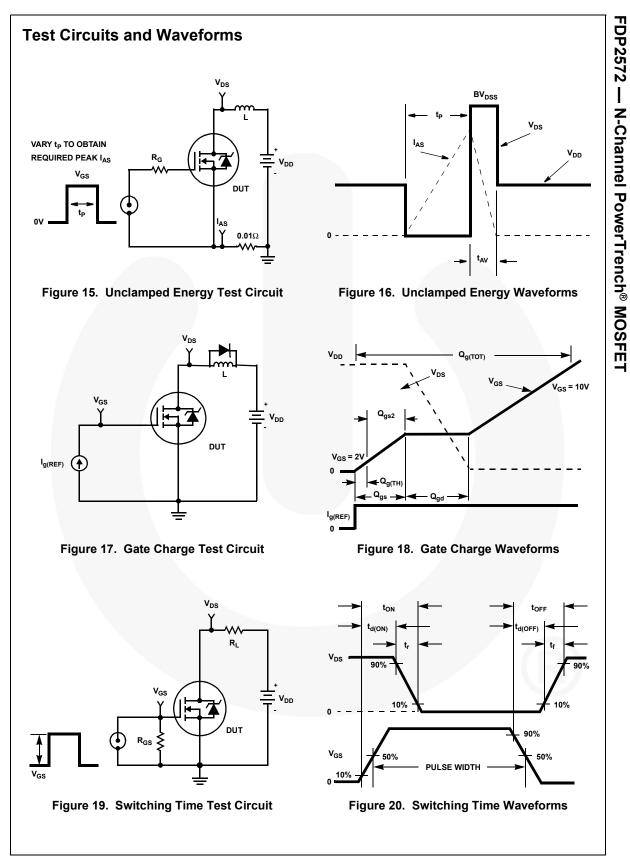
www.fairchildsemi.com



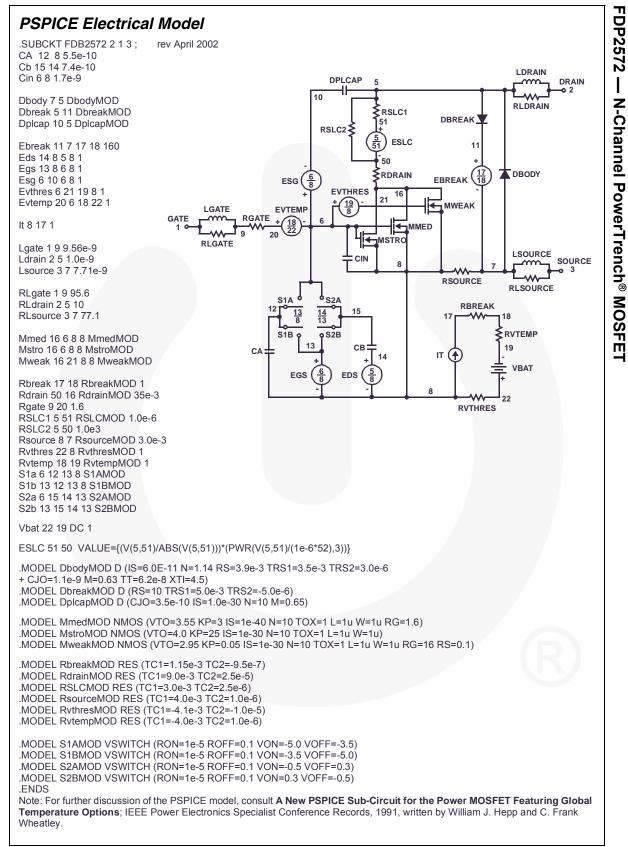
©2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1

www.fairchildsemi.com

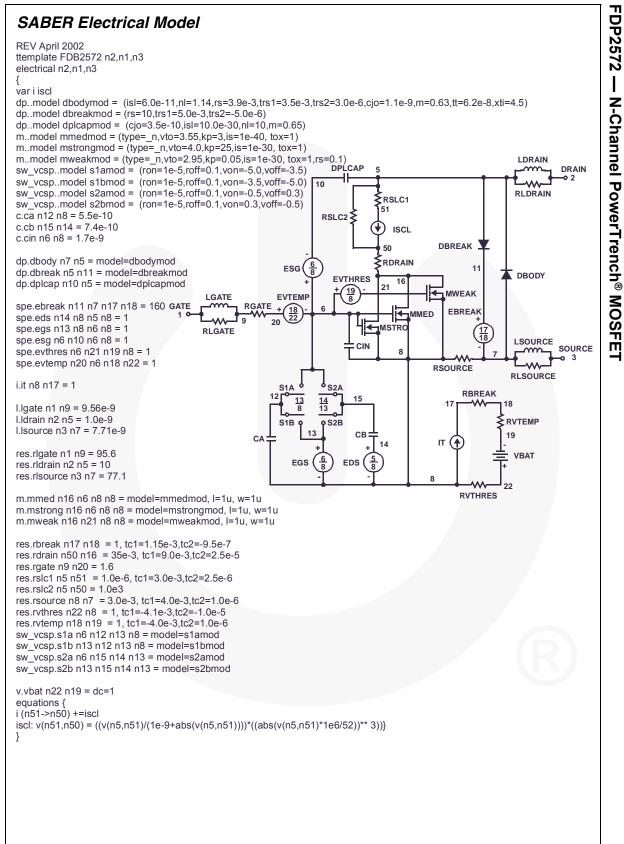




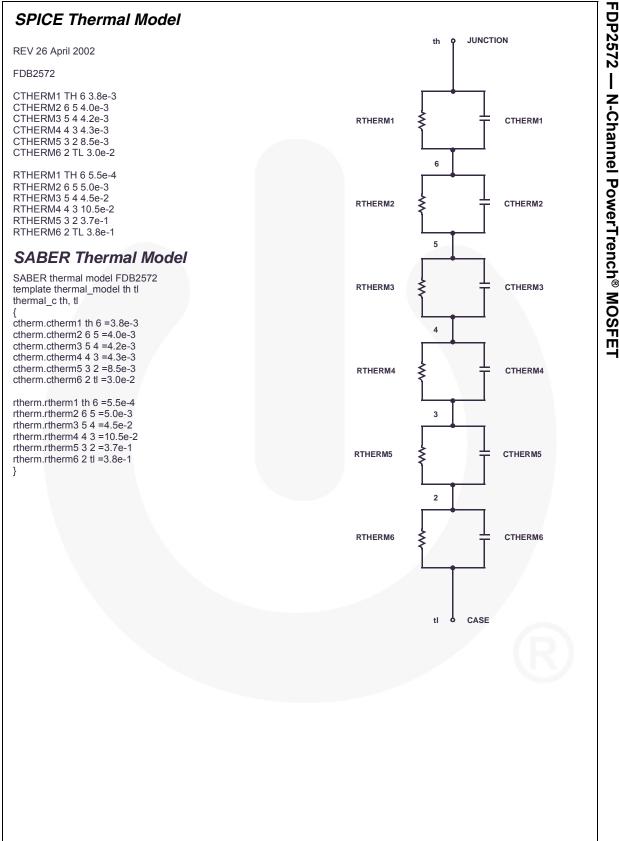
©2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1

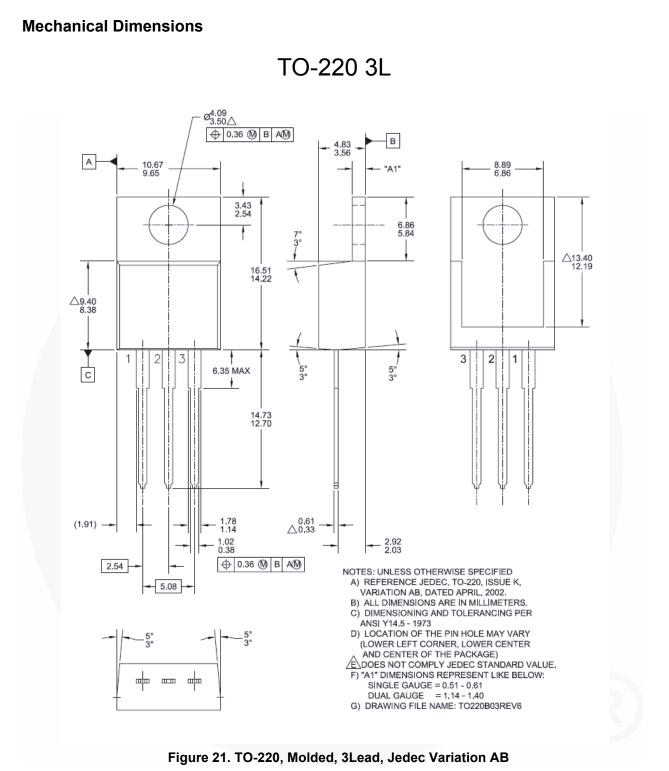


©2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1



@2002 Fairchild Semiconductor Corporation FDP2572 Rev. C1





FDP2572 — N-Channel PowerTrench[®] MOSFET

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT220-003

Dimension in Millimeters



Rev. 166

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC